NIKO-SEM

N- & P-Channel Enhancement Mode Field Effect Transistor

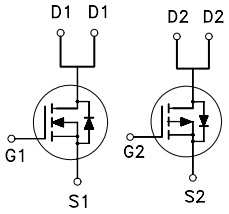
P3503QVG

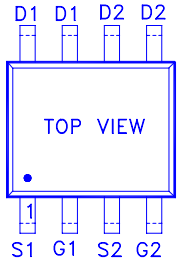
SOP-8

Lead-Free

PRODUCT SUMMARY

	$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
N-Channel	30	25mΩ	7A
P-Channel	-30	35mΩ	-6A





G : GATE
D : DRAIN
S : SOURCE

ABSOLUTE MAXIMUM RATINGS (T_C = 25 °C Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	N-Channel	P-Channel	UNITS
Drain-Source Voltage		V_{DS}	30	-30	V
Gate-Source Voltage		V_{GS}	±20	±20	V
Continuous Drain Current	T_C = 25 °C	I_D	7	-6	A
	T_C = 70 °C		6	-5	
Pulsed Drain Current[1]		I_{DM}	20	-20	
Power Dissipation	T_C = 25 °C	P_D	2		W
	T_C = 70 °C		1.3		
Junction & Storage Temperature Range		T_j, T_{stg}	-55 to 150		°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient	$R_{\theta JA}$	48	62.5	°C / W

[1]Pulse width limited by maximum junction temperature.
[2]Duty cycle ≤ 1%

ELECTRICAL CHARACTERISTICS (T_C = 25 °C, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS		LIMITS MIN	LIMITS TYP	LIMITS MAX	UNIT
STATIC							
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS} = 0V, I_D = 250µA	N-Ch	30			V
		V_{GS} = 0V, I_D = -250µA	P-Ch	-30			
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250µA	N-Ch	1	1.5	2.5	
		V_{DS} = V_{GS}, I_D = -250µA	P-Ch	-1	-1.5	-2.5	
Gate-Body Leakage	I_{GSS}	V_{DS} = 0V, V_{GS} = ±20V	N-Ch			±100	nA
		V_{DS} = 0V, V_{GS} = ±20V	P-Ch			±100	

Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 24V, V_{GS} = 0V	N-Ch			1	μA
		V_{DS} = -24V, V_{GS} = 0V	P-Ch			-1	
		V_{DS} = 20V, V_{GS} = 0V, T_J = 55 °C	N-Ch			10	
		V_{DS} = -20V, V_{GS} = 0V, T_J = 55 °C	P-Ch			-10	
On-State Drain Current[1]	$I_{D(ON)}$	V_{DS} = 5V, V_{GS} = 10V	N-Ch	20			A
		V_{DS} =-5V, V_{GS} = -10V	P-Ch	-20			
Drain-Source On-State Resistance[1]	$R_{DS(ON)}$	V_{GS} = 4.5V, I_D = 6A	N-Ch		25	37	mΩ
		V_{GS} = -4.5V, I_D = -5A	P-Ch		44	60	
		V_{GS} = 10V, I_D = 7A	N-Ch		18	25	
		V_{GS} = -10V, I_D = -6A	P-Ch		28	35	
Forward Transconductance[1]	g_{fs}	V_{DS} = 5V, I_D = 7A	N-Ch		19		S
		V_{DS} = -5V, I_D = -5A	P-Ch		10		

DYNAMIC							
Input Capacitance	C_{iss}	N-Channel V_{GS} = 0V, V_{DS} = 10V, f = 1MHz P-Channel V_{GS} = 0V, V_{DS} = -10V, f = 1MHz	N-Ch		790	988	pF
			P-Ch		970	1213	
Output Capacitance	C_{oss}		N-Ch		175	245	
			P-Ch		370	520	
Reverse Transfer Capacitance	C_{rss}		N-Ch		65	98	
			P-Ch		180	270	
Total Gate Charge[2]	Q_g	N-Channel V_{DS} = 0.5$V_{(BR)DSS}$, V_{GS} = 10V, I_D = 6A P-Channel V_{DS} = 0.5$V_{(BR)DSS}$, V_{GS} = -10V, I_D = -5A	N-Ch		16		nC
			P-Ch		28		
Gate-Source Charge[2]	Q_{gs}		N-Ch		2.5		
			P-Ch		6		
Gate-Drain Charge[2]	Q_{gd}		N-Ch		2.1		
			P-Ch		12		
Turn-On Delay Time[2]	$t_{d(on)}$	N-Channel V_{DD} = 10V $I_D \cong$ 1A, V_{GS} = 10V, R_{GEN} = 6Ω P-Channel V_{DD} = -15V $I_D \cong$ -1A, V_{GS} = -10V, R_{GEN} = 6Ω	N-Ch		2.2	4.4	nS
			P-Ch		20		
Rise Time[2]	t_r		N-Ch		7.5	15	
			P-Ch		17		
Turn-Off Delay Time[2]	$t_{d(off)}$		N-Ch		11.8	21.3	
			P-Ch		160		
Fall Time[2]	t_f		N-Ch		3.7	7.4	
			P-Ch		75		

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_C = 25 °C)							
Continuous Current	I_S		N-Ch			1.3	A
			P-Ch			-1.3	
Pulsed Current[3]	I_{SM}		N-Ch			2.6	A
			P-Ch			-2.6	
Forward Voltage[1]	V_{SD}	I_F = 1A, V_{GS} = 0V	N-Ch			1	V
		I_F = -1A, V_{GS} = 0V	P-Ch			-1	

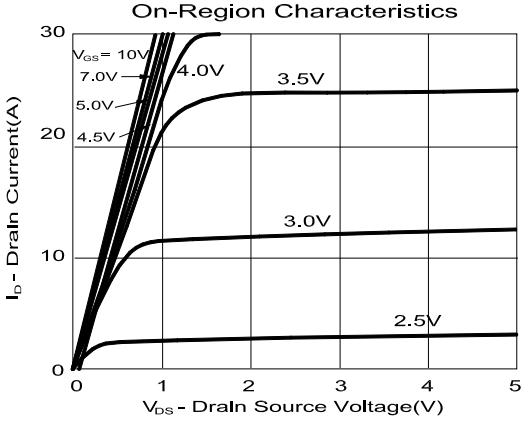
[1]Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.
[2]Independent of operating temperature.
[3]Pulse width limited by maximum junction temperature.

REMARK: THE PRODUCT MARKED WITH "P3503QVG", DATE CODE or LOT #

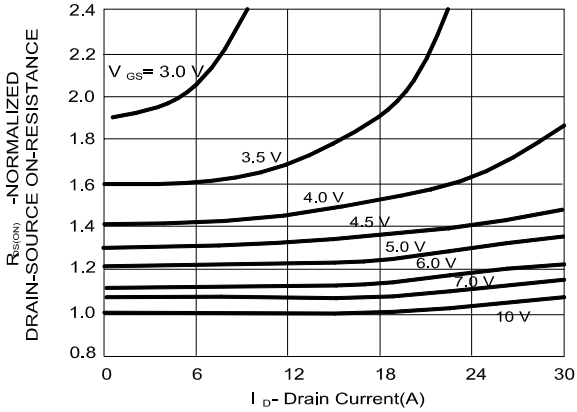
Orders for parts with Lead-Free plating can be placed using the PXXXXXXG parts name.

TYPICAL PERFORMANCE CHARACTERISTICS
N-CHANNEL

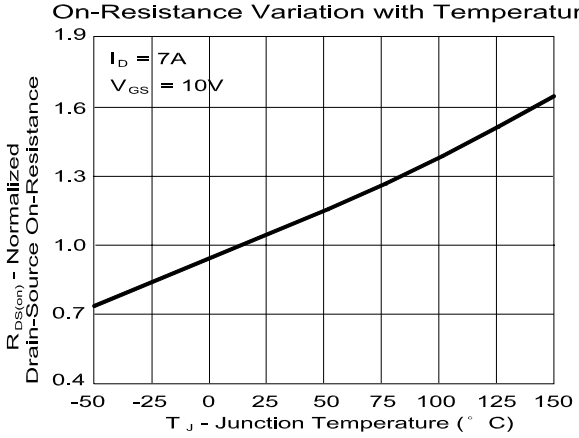
On-Region Characteristics



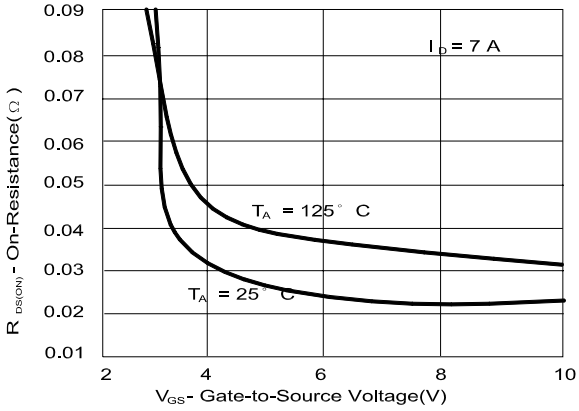
On-Resistance Variation with Drain Current and Gate Voltage



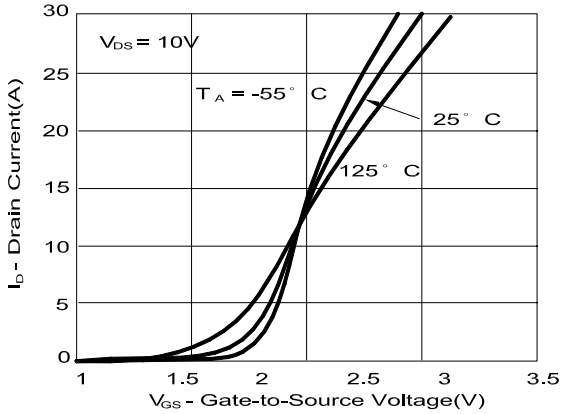
On-Resistance Variation with Temperature



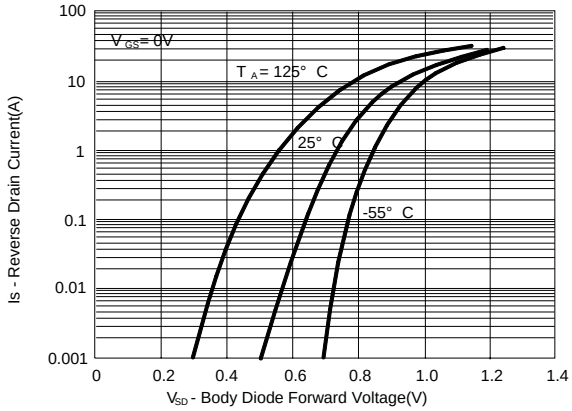
On-Resistance Variation with Gate-to-Source Voltage



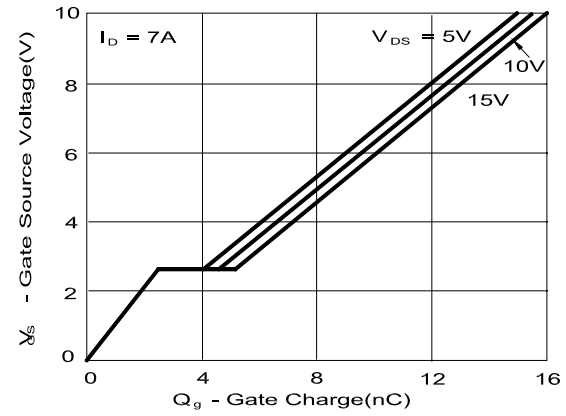
Transfer Characteristics



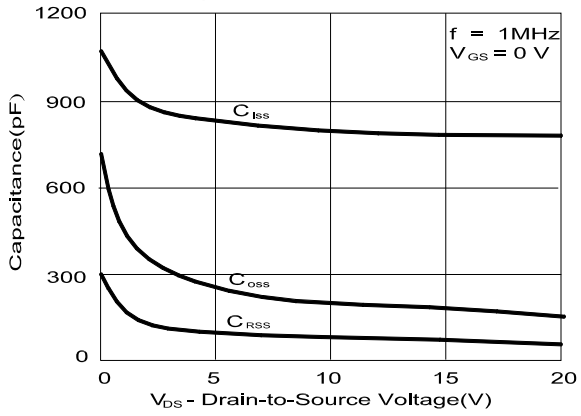
Body Diode Forward Voltage Variation with Source Current and Temperature



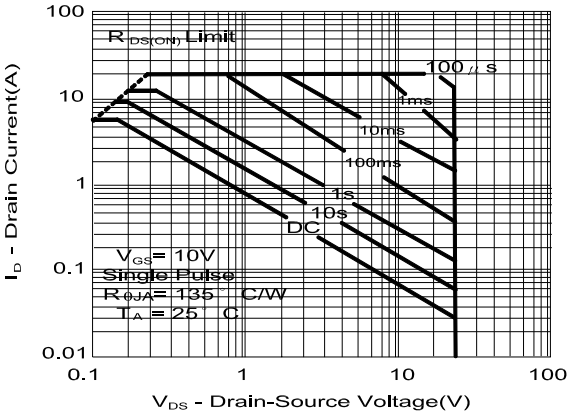
Gate Charge Characteristics



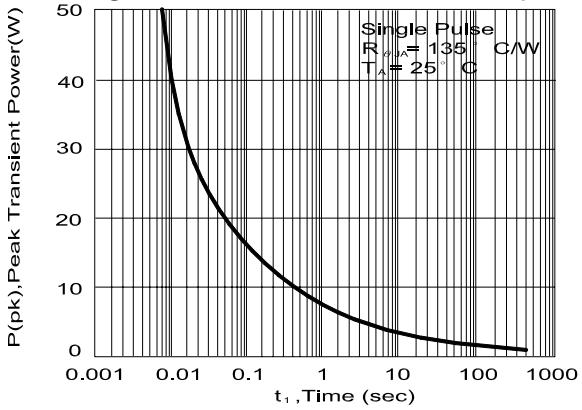
Capacitance Characteristics



Maximum Safe Operating Area

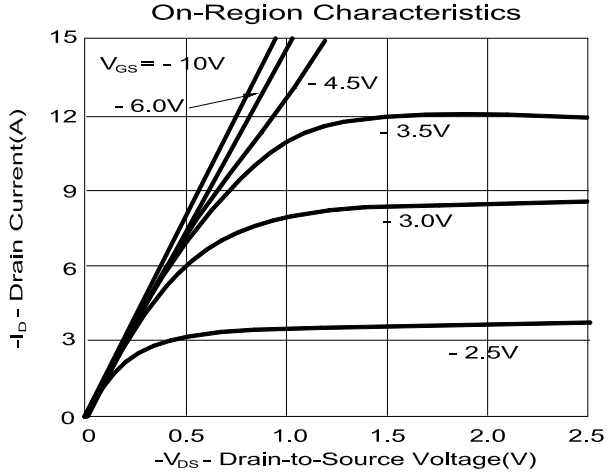


Single Pulse Maximum Power Dissipation

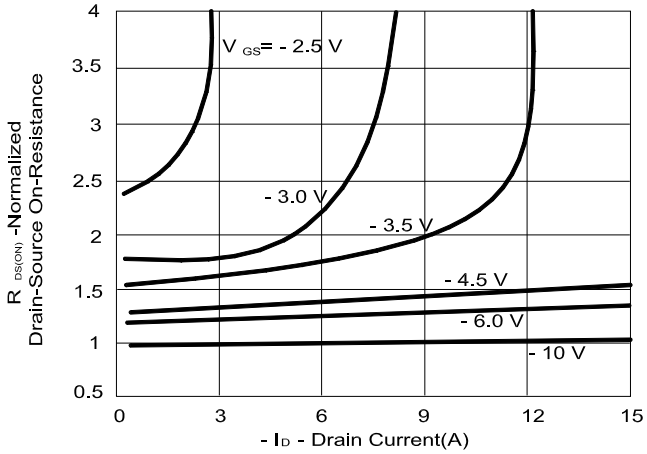


P-CHANNEL

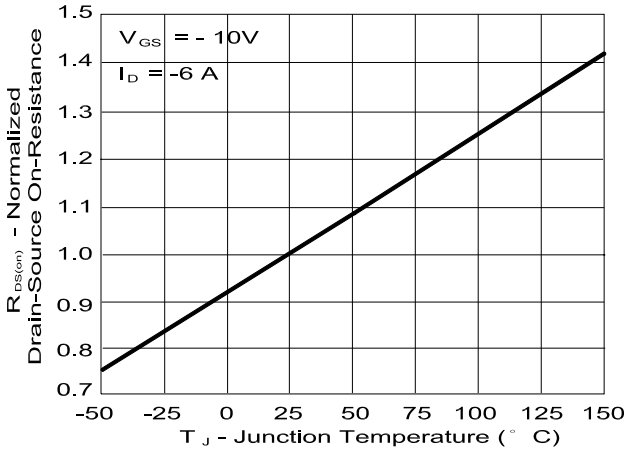
On-Region Characteristics



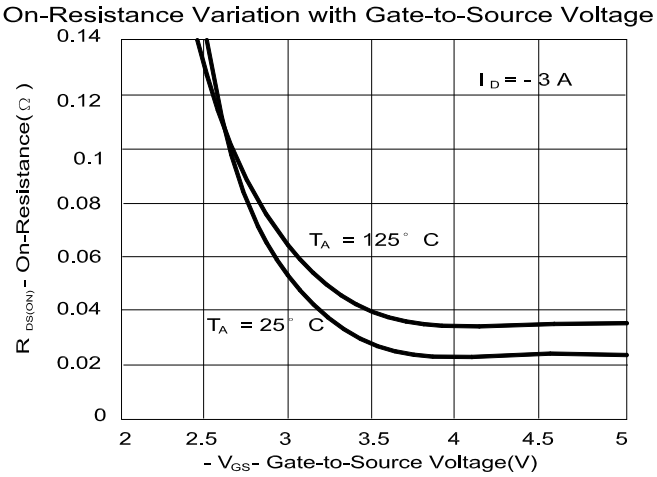
On-Resistance Variation with Drain Current and Gate Voltage



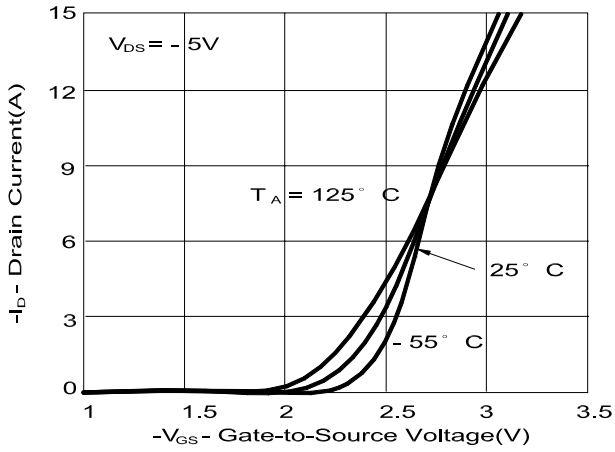
On-Resistance Variation with Temperature



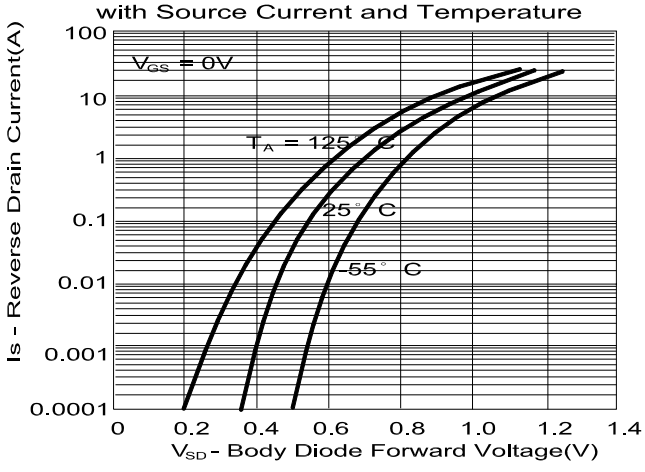
On-Resistance Variation with Gate-to-Source Voltage



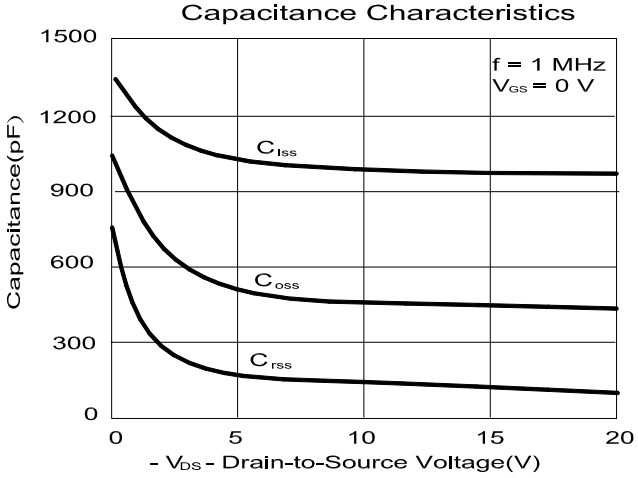
Transfer Characteristics



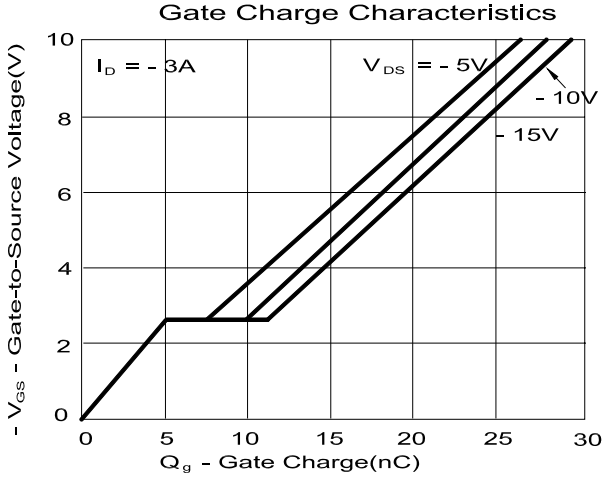
Body Diode Forward Voltage Variation
with Source Current and Temperature



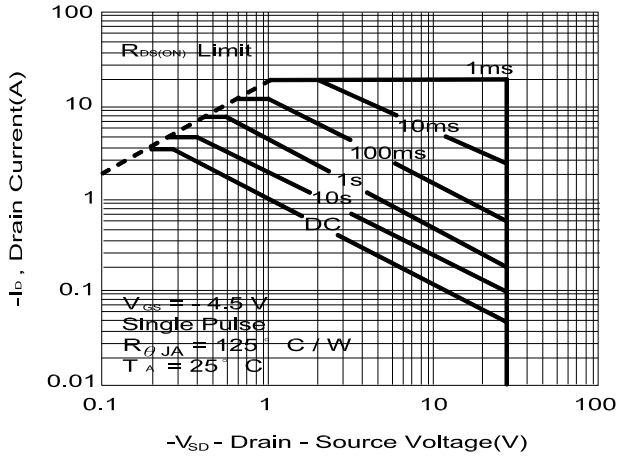
Capacitance Characteristics



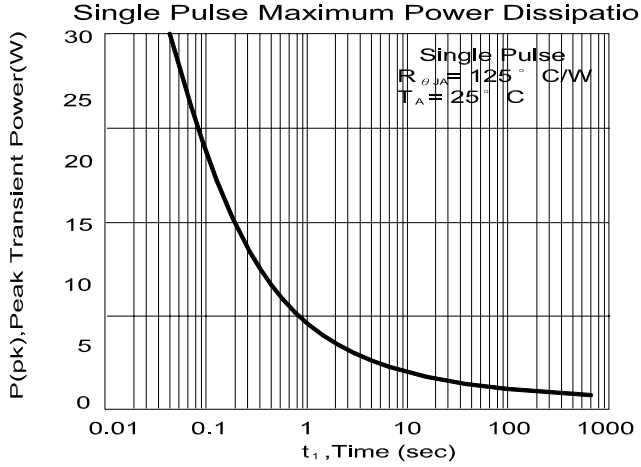
Gate Charge Characteristics



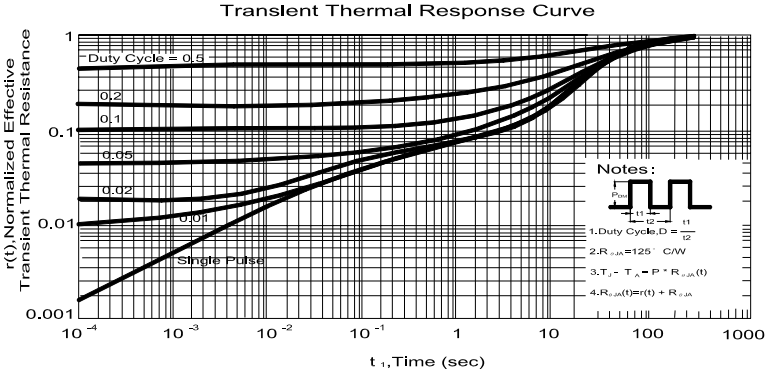
Maximum Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve



SOIC-8(D) MECHANICAL DATA

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	4.8	4.9	5.0	H	0.5	0.715	0.83
B	3.8	3.9	4.0	I	0.18	0.254	0.25
C	5.8	6.0	6.2	J		0.22	
D	0.38	0.445	0.51	K	0°	4°	8°
E		1.27		L			
F	1.35	1.55	1.75	M			
G	0.1	0.175	0.25	N